

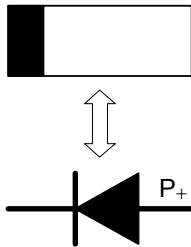
SMD Schottky Barrier Diode

■ Features

$$I_O = 200\text{mA}$$

$$V_R = 30\text{V}$$

- Designed for mounting on small surface.
- Extremely thin package.
- Low drop-down voltage.
- Majority carrier conduction
- Lead-free device

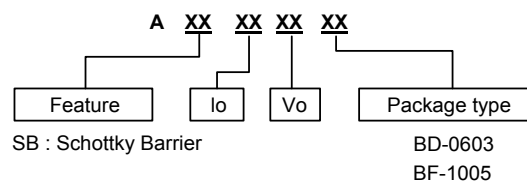


■ Mechanical Data

- Case :0603(1608) 1005(2512) standard package, molded plastic.
- Terminals : Gold plated, solderable per MIL-STD-750, method 2026.
- Polarity : Indicated by cathode band.
- Mounting position : Any.
- Weight : BD:0.003gram (approximately)
BF:0.006gram (approximately)

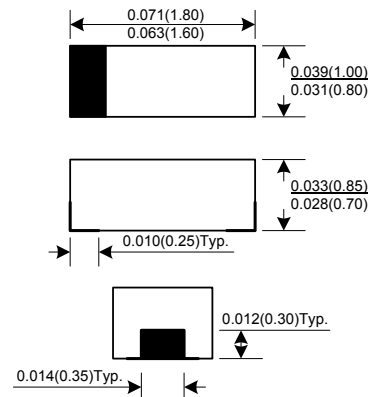
■ Ordering information

www.DataSheet4U.com



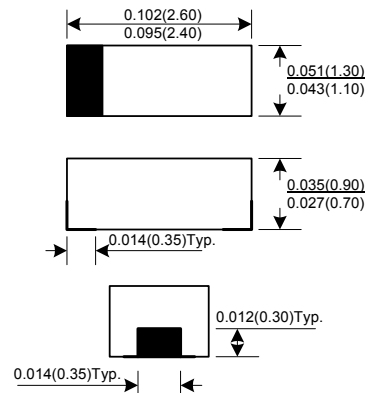
■ General Description

0603(1608)



Dimensions in inches and (millimeter)

1005(2512)



Dimensions in inches and (millimeter)



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■ Maximum Rating (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V_{RRM}	Repetitive peak reverse voltage		-	-	35	V	
V_R	Reverse voltage		-	-	30	V	
I_O	Average forward current		-	-	200	mA	
I_{FSM}	Forward current, surge peak	0603	8.3ms single half sine-wave superimposed on rate load (JEDEC method)	-	2000	-	mA
		1005		-	3000	-	
P_D	Power Dissipation	0603	-	-	150	mW	
		1005	-	-	250		
T_{STG}	Storage temperature		-40	-	+125	$^\circ\text{C}$	
T_j	Junction temperature		-40	-	+125	$^\circ\text{C}$	

■ Electrical Characteristics (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Forward voltage	$I_F=200\text{mA DC}$	-	-	0.50	V
I_R	Reverse current	$V_R=30\text{V}$	-	-	30	μA
C_T	Capacitance between terminals	$F=1\text{MHz}$, and 10 VDC reverse voltage	-	9	-	pF

■ Rating And Characteristic Curves

Fig. 1 - Forward characteristics

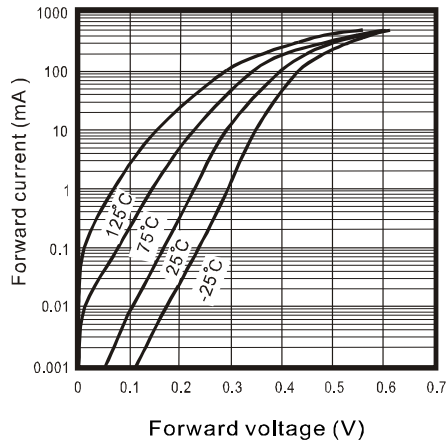


Fig. 2 - Reverse characteristics

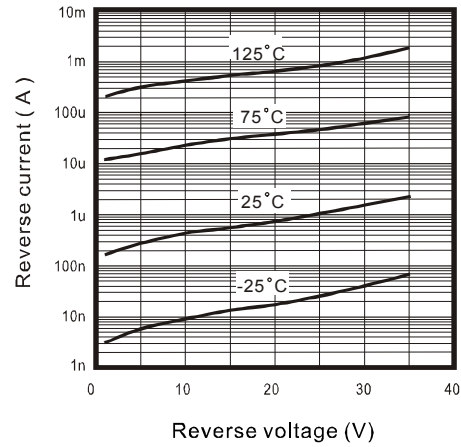


Fig. 3 - Capacitance between terminals characteristics

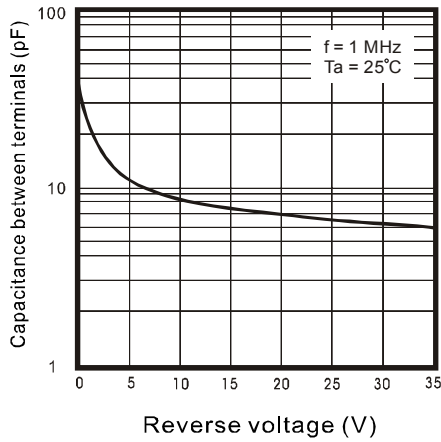
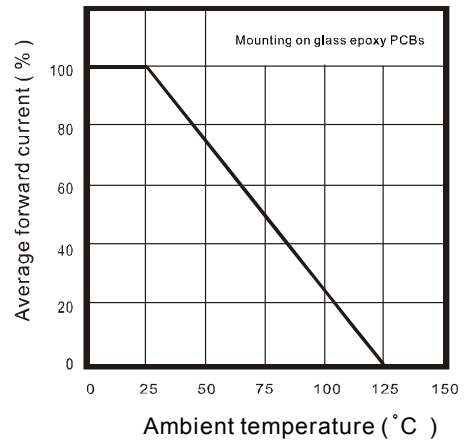


Fig. 4 - Current derating curve



■ Marking Information

